

5x7mm Precision TCXO In Stock at Digi-Key

CONNOR WINFIELD

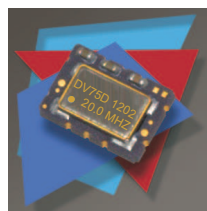


2111 Comprehensive Drive
Aurora, Illinois 60505
Phone: 630-851-4722
Fax: 630-851-5040
www.conwin.com

US Headquarters:
630-851-4722
European Headquarters:
+353-61-472221

Description:

The Connor-Winfield's DV75D is a 5x7mm Surface Mount Temperature Compensated Crystal Controlled Oscillator (TCXO) with LVC MOS output. Through the use of Analog Temperature Compensation, the DV75D is capable of holding sub 1-ppm stabilities over the -40 to 85°C temperature range.



Applications:

GR-253-CORE (SMC)
ITU-T-G.813 Option 1 and 2 (SEC)

Features:

Model: DV75D
TCXO
3.3 Vdc Operation
LVC MOS Output
Frequency Stability: ± 1.0 ppm
Temperature Range: -40 to 85°C
Low Jitter <1ps RMS
5x7mm Surface Mount Package
Tape and Reel Packaging
RoHS Compliant / Pb Free ✓ RoHS

Absolute Maximum Ratings

Parameter	Minimum	Nominal	Maximum	Units	Notes
Storage Temperature	-55	-	85	°C	
Supply Voltage (Vcc)	-0.5	-	6.0	Vdc	
Input Voltage	-0.5	-	Vcc+0.5	Vdc	

Operating Specifications

Parameter	Minimum	Nominal	Maximum	Units	Notes
Nominal Frequency (Fo)	-	10.0, 12.8 or 20.0	-	MHz	
Frequency Calibration @ 25 °C	-1.0	-	1.0	ppm	1
Frequency Stability vs. Temperature	-1.0	-	1.0	ppm	2
Frequency vs. Load Stability	-0.2	-	0.2	ppm	±5%
Frequency vs. Voltage Stability	-0.2	-	0.2	ppm	±5%
Static Temperature Hysteresis	-	-	0.4	ppm	3
Aging	-1.0	-	1.0	ppm/year	
Operating Temperature Range:	-40	-	85	°C	
Supply Voltage (Vcc)	3.135	3.3	3.465	Vdc	±5%
Supply Current (Icc)	-	-	6	mA	
Period Jitter	-	3	5	ps rms	
Integrated Phase Jitter	-	0.5	1.0	ps rms	4
Typical Phase Noise Fo = 20.0 MHz					
SSB Phase Noise at 10Hz offset	-	-80	-	dBc/Hz	
SSB Phase Noise at 100Hz offset	-	-110	-	dBc/Hz	
SSB Phase Noise at 1KHz offset	-	-135	-	dBc/Hz	
SSB Phase Noise at 10KHz offset	-	-150	-	dBc/Hz	
SSB Phase Noise at 100KHz offset	-	-150	-	dBc/Hz	
Start-up Time	-	-	10	ms	

LVC MOS Output Characteristics

Parameter	Minimum	Nominal	Maximum	Units	Notes
Load	-	15	-	pF	5
Voltage (High) (Voh)	90%Vcc	-	-	Vdc	
(Low) (Vol)	-	-	10%Vcc	Vdc	
Duty Cycle at 50% of Vcc	45	50	55	%	
Rise / Fall Time 10% to 90%	-	-	8	ns	

Package Characteristics

Package: Hermetically sealed crystal mounted on a ceramic package

Environmental Characteristics

Vibration: Vibration per Mil Std 883E Method 2007.3 Test Condition A
Shock: Mechanical Shock per Mil Std 883E Method 2002.4 Test Condition B.
Soldering Process: RoHS compliant lead free. See soldering profile on page 2.

Ordering Information

DV75D-010.0M*, DV75D-012.8M* or DV75D-020.0M*

* For the tape and reel option, add -T to the end of the part number. Example: DV75D-010.0M-T

Notes:

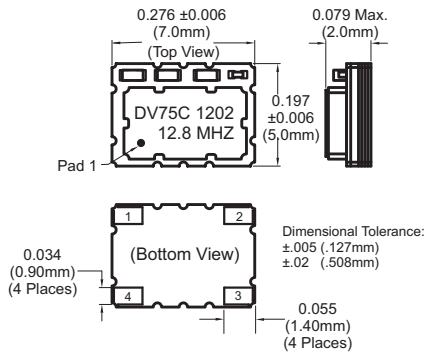
1. Initial calibration @ 25°C. Specifications at time of shipment after 48 hours of operation.
2. Frequency stability vs. change in temperature. $\pm(F_{max} - F_{min})/(2 \cdot F_0)$.
3. Frequency change after reciprocal temperature ramped over the operating range. Frequency measured before and after at 25°C.
4. BW = 12 KHz to 20 MHz.
5. For best performance it is recommended that the circuit connected to this output should have an equivalent input capacitance of 15pF.

Specifications subject to change without notice. All dimensions in inches. © Copyright 2012 The Connor-Winfield Corporation

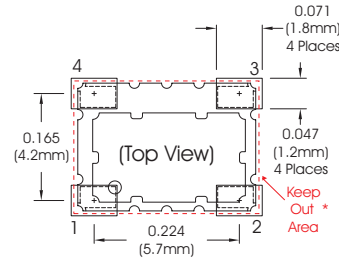


Bulletin **Tx356**
Page **1 of 2**
Revision **02**
Date **15 Apr 2013**

Package Layout



Suggested Pad Layout

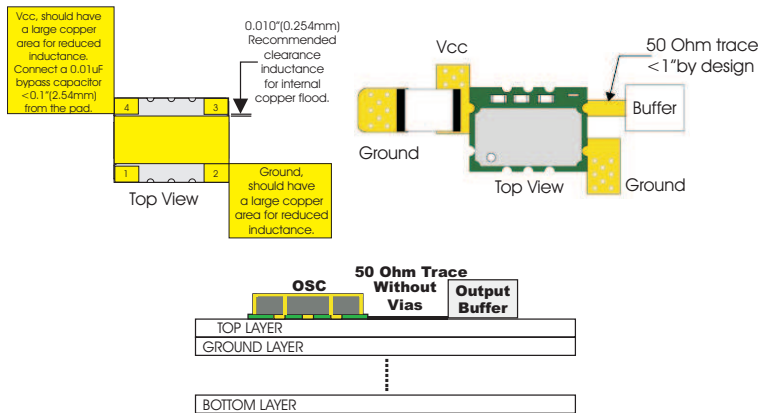


* Do not route any traces in the keep out area. It is recommended the next layer under the keep out area is to be ground plane.

Pad Connections

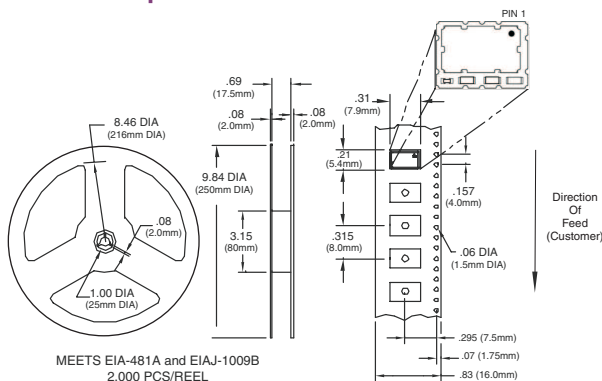
1:	N/C
2:	Ground
3:	Output (Fo)
4:	Supply Voltage (Vcc)

Design Recommendations



Attention: To achieve optimal frequency stability, and in some cases to meet the specification stated on this data sheet, it is required that the circuit connected to this TCXO output must have the equivalent input capacitance that is specified by the nominal load capacitance. Deviations from the nominal load capacitance will have a graduated effect on the stability of approximately 20 ppb per pF load difference.

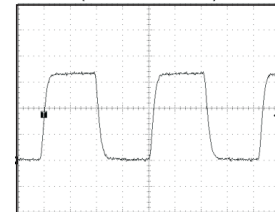
Tape and Reel Dimensions



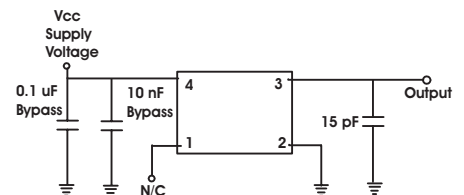
Revision History

Revision 00	Data sheet released 01/11/12
Revision 01	Removed tri-state information from features and description. 11/26/12.
Revision 02	Added "Applications" 04/15/13

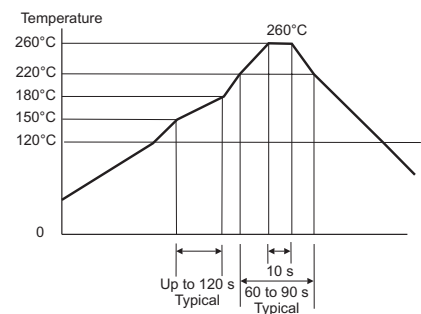
Output Waveform



Test Circuit



Solder Profile



Meets IPC/JEDEC J-STD-020C

Bulletin	Tx356
Page	2 of 2
Revision	02
Date	15 Apr 2013